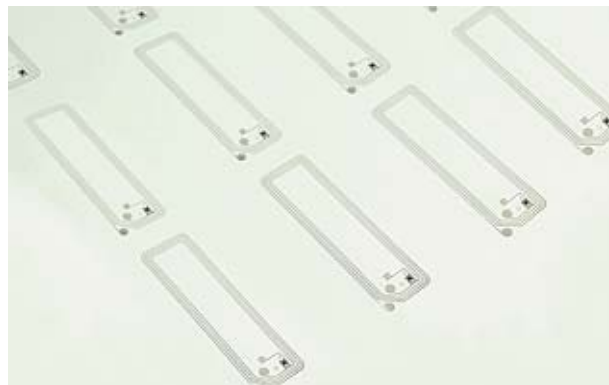


PC Thinlam®

ISO 14443

- Thinnest RFID prelaminate available, based on Flip-Chip technology
- High card surface quality without dents and dimples and good printability
- ICAO compliant with NXP SmartMX family



Applications	Access Control	Traffic control systems, corporate parking lots, car rental parks, premises access, ski access, events
	eGovernment:	eID cards, ePassport (e.g. for passport data pages) eDrivers license, border control

Specifications

Product thickness	approx. 260µm	Integrated Circuit	NXP Mifare family NXP SmartMX family
Substrate	Polycarbonate, white		
Antenna	conductive silver ink		(Chip alternatives upon request)
Operating frequency	13,56MHz	Delivery form	all common card industry formats max. sheet format 56up

Features and Options

Reliability:	acc. to ISO 10373-1	PC Thinlam - NXP SmartMX	fulfills state printer requirements
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For further Information please contact the KSW Sales or Customer Service Team:
 E-Mail: sales@ksw-microtec.de | Web: www.ksw-microtec.de | Phone.: +49 351 88 960 10